



Features

- For surface mounted applications
- Extremely Low Thermal Resistance
- Easy Pick And Place
- High temperature soldering: 250°C for 10 seconds At Terminals
- High Current Capability With Low Forward Voltage

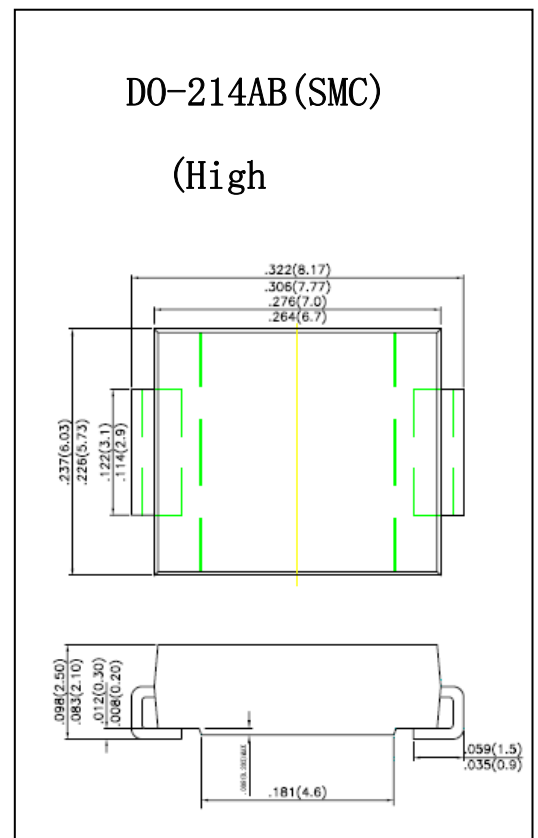
Maximum Ratings

- Operating & Storage Temperature: -55°C to +125°C
- Maximum Junction Temperature: 150°C
- Typical Thermal Resistance: 18°C/W Junction To Lead

Item Number	Device Marking	Maximum Recurrent Peak Reverse Voltage	Maximum RMS Voltage	Maximum DC Blocking Voltage
SK82	SK82	20V	14V	20V
SK83	SK83	30V	21V	30V
SK84	SK84	40V	28V	40V
SK845	SK845	45V	31.5V	45V
SK85	SK85	50V	35V	50V
SK86	SK86	60V	42V	60V
SK88	SK88	80V	56V	80V
SK810	SK810	100V	70V	100V

DO-214AB (SMC)

(High)



Electrical Characteristics @ 25°C Unless Otherwise Specified

Average Forward Current	$I_{F(AV)}$	8.0A	$T_L=95^\circ\text{C}$
Peak Forward Surge Current	I_{FSM}	200A	8.3ms, half Sine
Maximum Instantaneous Forward Voltage	V_F	.65V .85V	$I_{FM}=8.0A$; $T_J=25^\circ\text{C}^*$
Maximum DC Reverse Current At Rated DC Blocking Voltage	I_R	1mA 20mA	$T_J=25^\circ\text{C}$ $T_J=100^\circ\text{C}$
Typical Junction Capacitance	C_J	400pF	Measured at 1.0MHz, $V_R=4.0V$